

DATA SHEET

BFR93A

NPN 6 GHz wideband transistor

Product specification
Supersedes data of September 1995

1997 Oct 29



NPN 6 GHz wideband transistor

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FEATURES

- High power gain
- Low noise figure
- Very low intermodulation distortion.

APPLICATIONS

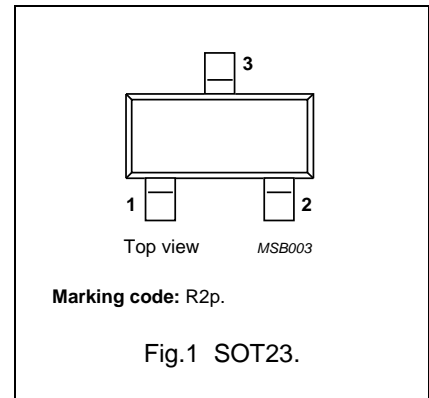
- RF wideband amplifiers and oscillators.

DESCRIPTION

NPN wideband transistor in a plastic SOT23 package.
PNP complement: BFT93.

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | base |
| 2 | emitter |
| 3 | collector |



QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | TYP. | MAX. | UNIT |
|-----------|-------------------------------|---|------|------|------|
| V_{CBO} | collector-base voltage | open emitter | — | 15 | V |
| V_{CEO} | collector-emitter voltage | open base | — | 12 | V |
| I_C | collector current (DC) | | — | 35 | mA |
| P_{tot} | total power dissipation | $T_s \leq 95\text{ }^\circ\text{C}$ | — | 300 | mW |
| C_{re} | feedback capacitance | $I_C = 0$; $V_{CE} = 5\text{ V}$; $f = 1\text{ MHz}$ | 0.6 | — | pF |
| f_T | transition frequency | $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$ | 6 | — | GHz |
| G_{UM} | maximum unilateral power gain | $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | 13 | — | dB |
| | | $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | 7 | — | dB |
| F | noise figure | $I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $\Gamma_s = \Gamma_{opt}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | 1.9 | — | dB |
| V_O | output voltage | $d_{im} = -60\text{ dB}$; $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25\text{ }^\circ\text{C}$; $f_p + f_q - f_r = 793.25\text{ MHz}$ | 425 | — | mV |

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------|---------------------------|--|------|------|------------------|
| V_{CBO} | collector-base voltage | open emitter | — | 15 | V |
| V_{CEO} | collector-emitter voltage | open base | — | 12 | V |
| V_{EBO} | emitter-base voltage | open collector | — | 2 | V |
| I_C | collector current (DC) | | — | 35 | mA |
| P_{tot} | total power dissipation | $T_s \leq 95\text{ }^\circ\text{C}$; note 1 | — | 300 | mW |
| T_{stg} | storage temperature | | −65 | +150 | $^\circ\text{C}$ |
| T_j | junction temperature | | — | +175 | $^\circ\text{C}$ |

Note

1. T_s is the temperature at the soldering point of the collector pin.

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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|----------------------------------|-------|------|
| $R_{th\ j-s}$ | thermal resistance from junction to soldering point | $T_s \leq 95\text{ °C}$; note 1 | 260 | K/W |

Note

- T_s is the temperature at the soldering point of the collector pin.

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

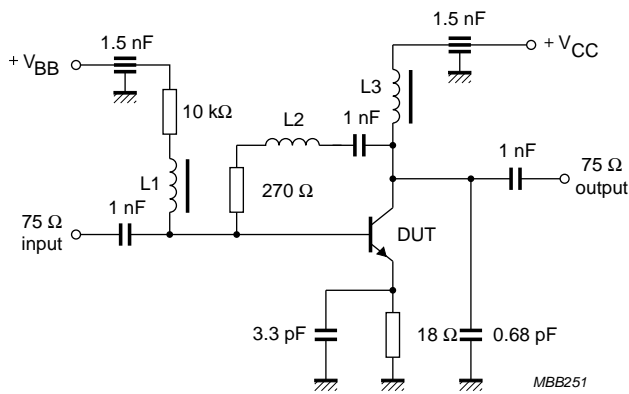
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|---|--|------|------|------|------|
| I_{CBO} | collector cut-off current | $I_E = 0$; $V_{CB} = 5\text{ V}$ | — | — | 50 | nA |
| h_{FE} | DC current gain | $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$ | 40 | 90 | — | |
| C_c | collector capacitance | $I_E = i_e = 0$; $V_{CB} = 5\text{ V}$; $f = 1\text{ MHz}$ | — | 0.7 | — | pF |
| C_e | emitter capacitance | $I_C = i_c = 0$; $V_{EB} = 0.5\text{ V}$; $f = 1\text{ MHz}$ | — | 1.9 | — | pF |
| C_{re} | feedback capacitance | $I_C = i_c = 0$; $V_{CE} = 5\text{ V}$; $f = 1\text{ MHz}$; $T_{amb} = 25\text{ °C}$ | — | 0.6 | — | pF |
| f_T | transition frequency | $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$ | 4.5 | 6 | — | GHz |
| G_{UM} | maximum unilateral power gain (note 1) | $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $T_{amb} = 25\text{ °C}$ | — | 13 | — | dB |
| | | $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $T_{amb} = 25\text{ °C}$ | — | 7 | — | dB |
| F | noise figure (note 2) | $I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 1\text{ GHz}$; $\Gamma_s = \Gamma_{opt}$; $T_{amb} = 25\text{ °C}$ | — | 1.9 | — | dB |
| | | $I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 2\text{ GHz}$; $\Gamma_s = \Gamma_{opt}$; $T_{amb} = 25\text{ °C}$ | — | 3 | — | dB |
| V_O | output voltage | notes 2 and 3 | — | 425 | — | mV |
| d_2 | second order intermodulation distortion | notes 2 and 4 | — | −50 | — | dB |

Notes

- G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)} \text{ dB}$.
- Measured on the same die in a SOT37 package (BFR91A).
- $d_{im} = -60\text{ dB}$ (DIN 45004B); $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25\text{ °C}$;
 $V_p = V_O$ at $d_{im} = -60\text{ dB}$; $f_p = 795.25\text{ MHz}$;
 $V_q = V_O - 6\text{ dB}$ at $f_q = 803.25\text{ MHz}$;
 $V_r = V_O - 6\text{ dB}$ at $f_r = 805.25\text{ MHz}$;
 measured at $f_p + f_q - f_r = 793.25\text{ MHz}$.
- $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25\text{ °C}$;
 $V_p = 200\text{ mV}$ at $f_p = 250\text{ MHz}$;
 $V_q = 200\text{ mV}$ at $f_q = 560\text{ MHz}$;
 measured at $f_p + f_q = 810\text{ MHz}$.

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L1 = L3 = 5 μH choke.
L2 = 3 turns 0.4 mm copper wire; winding pitch 1 mm; internal diameter 3 mm.

Fig.2 Intermodulation distortion and second harmonic distortion MATV test circuit.

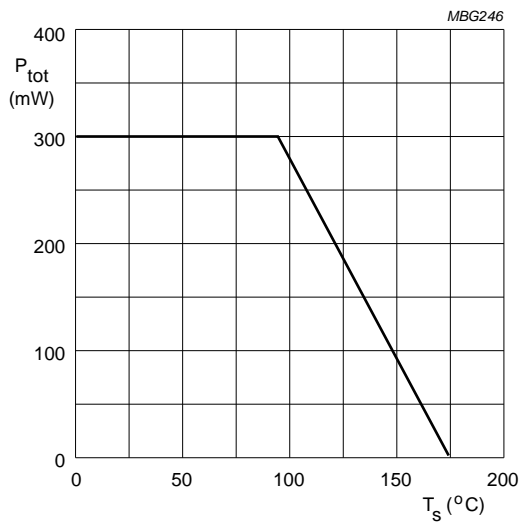
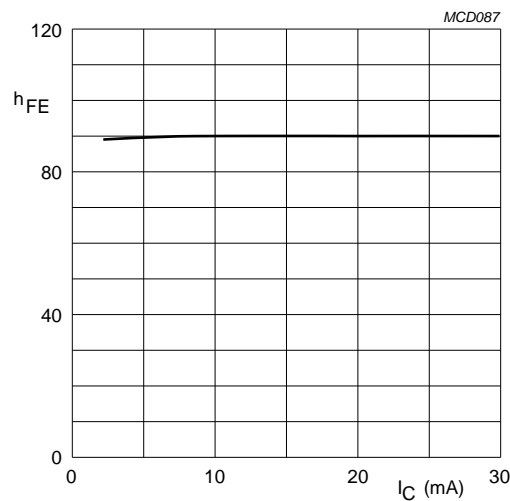


Fig.3 Power derating curve.

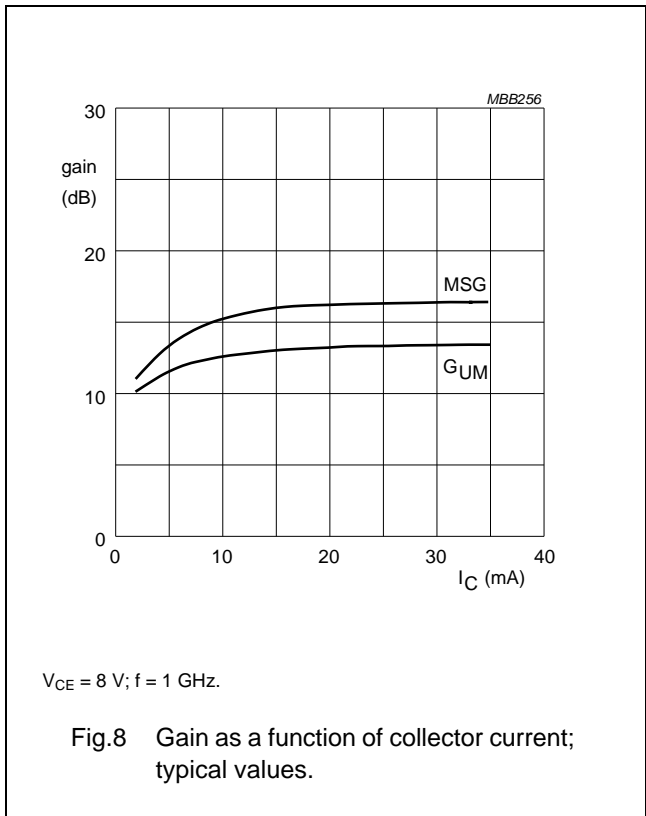
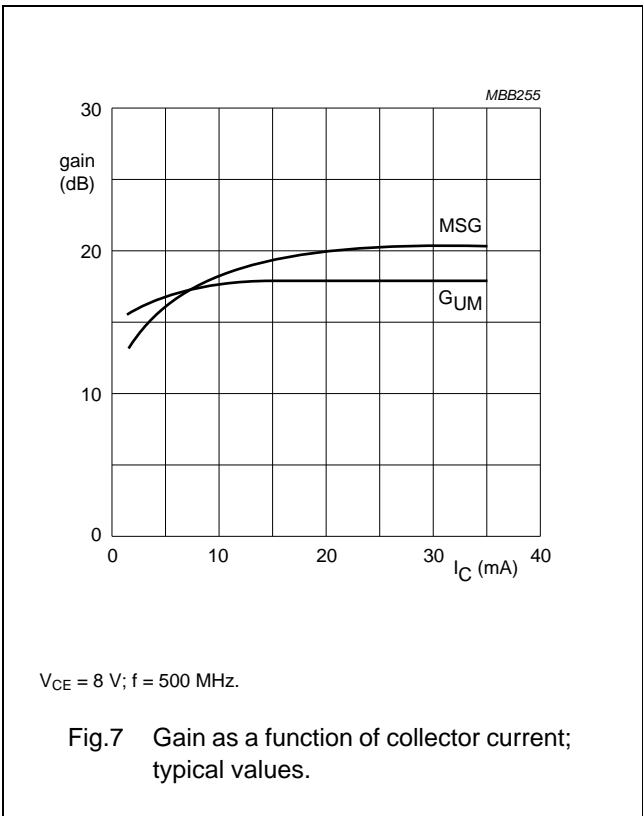
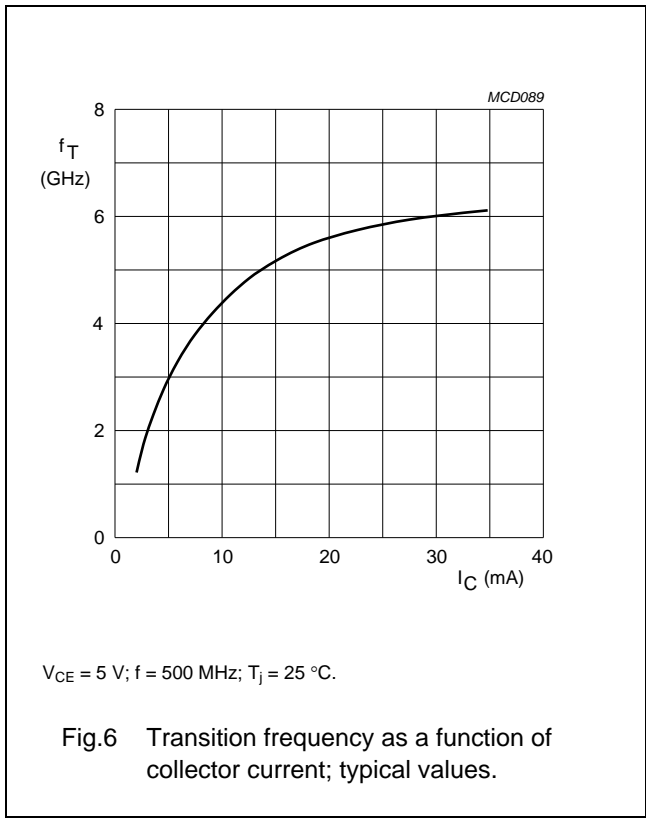
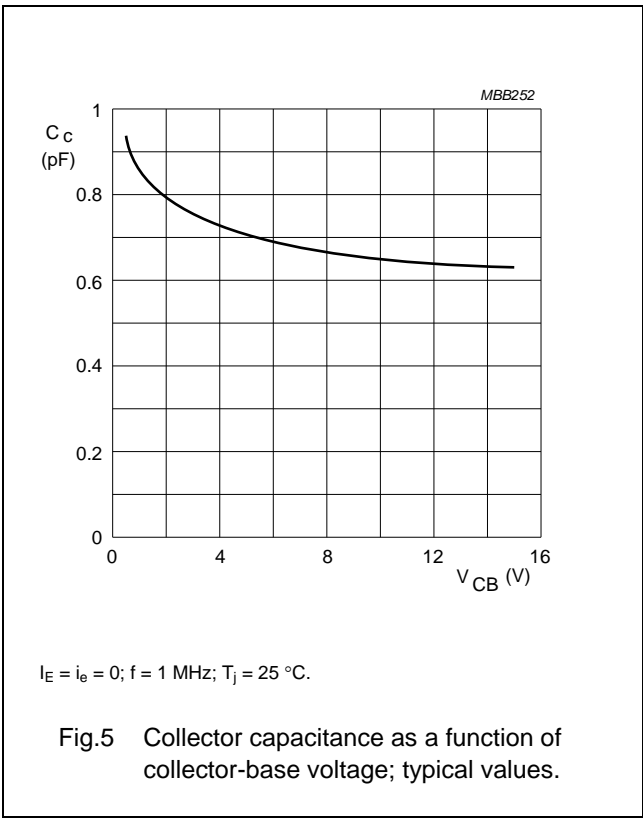


$V_{CE} = 5\text{ V}$; $T_j = 25\text{ °C}$.

Fig.4 DC current gain as a function of collector current.

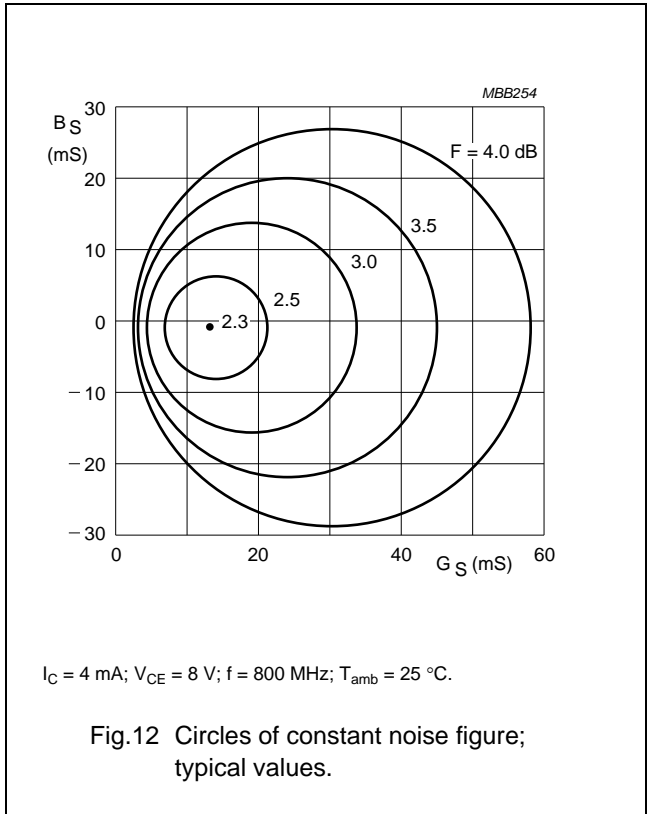
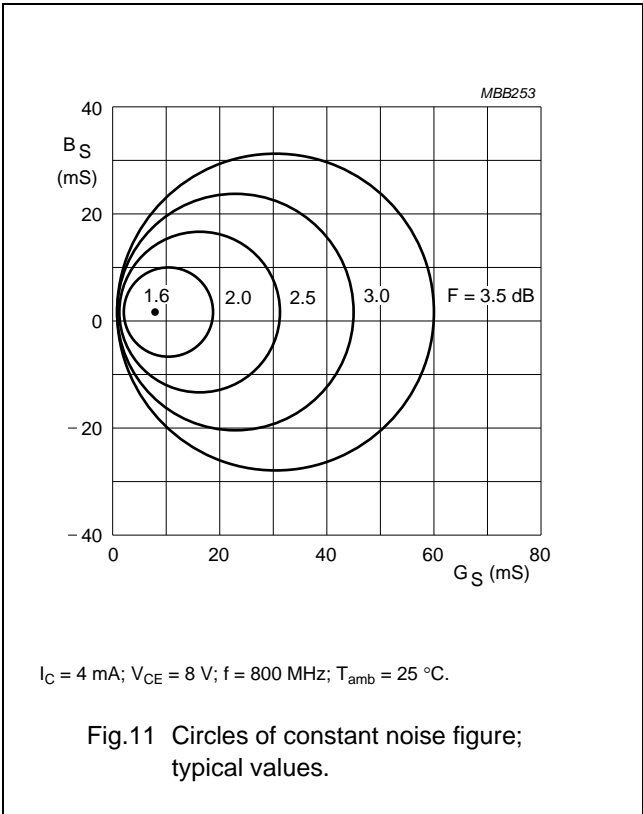
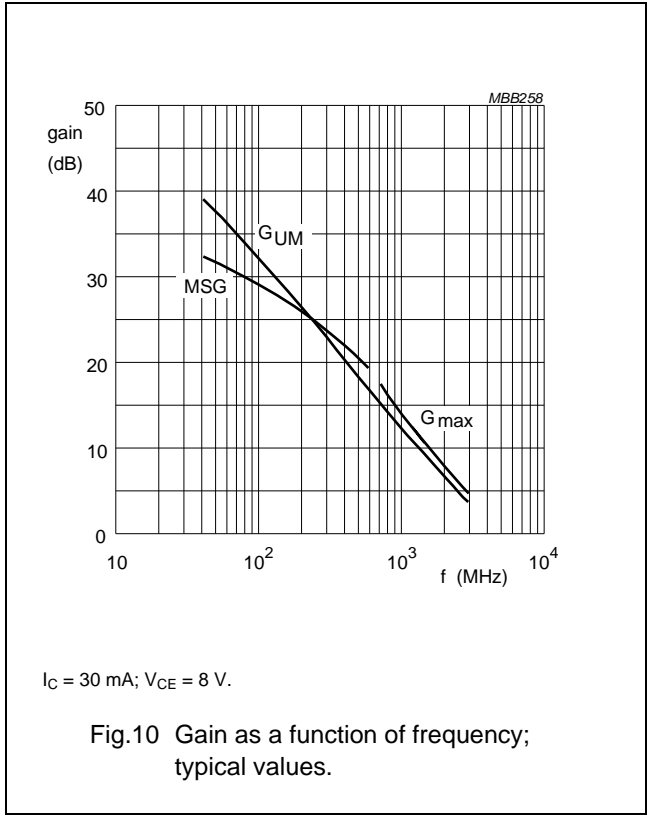
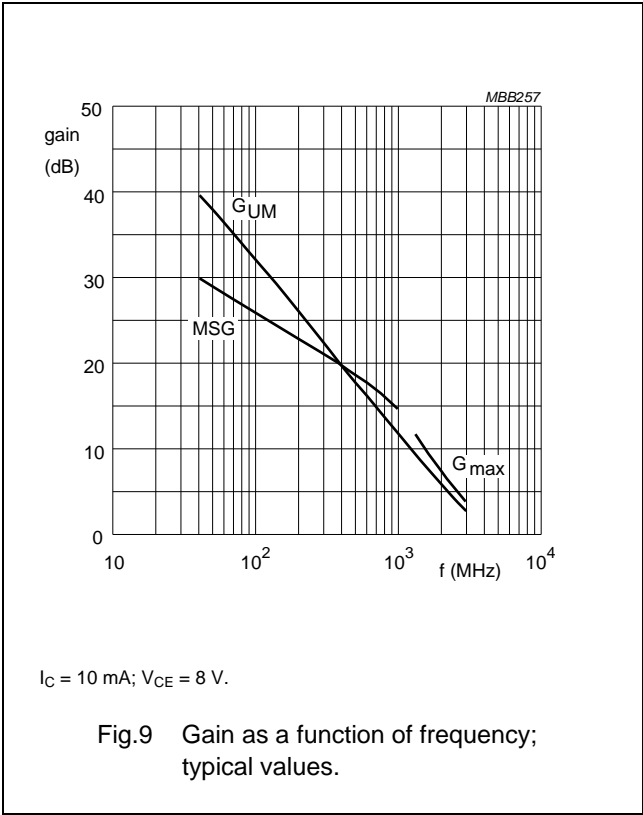
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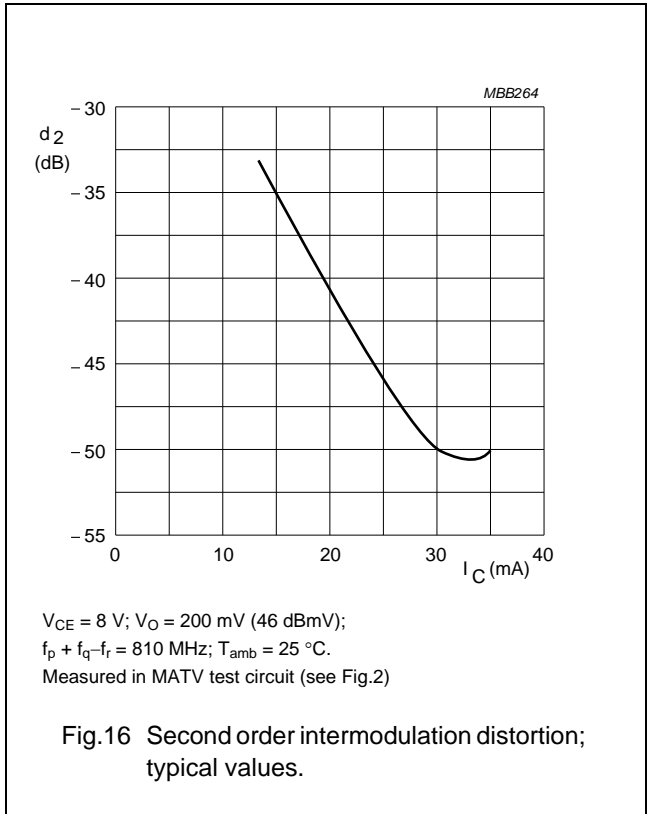
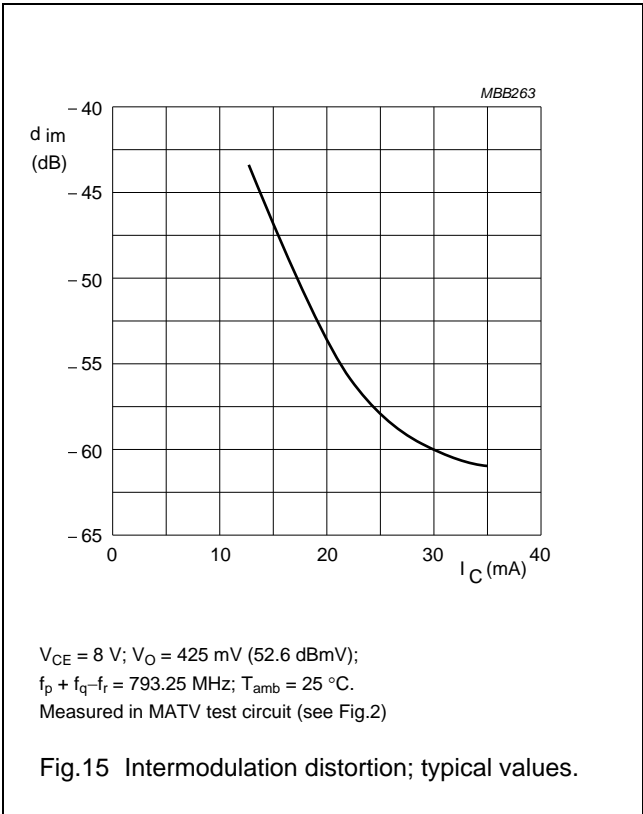
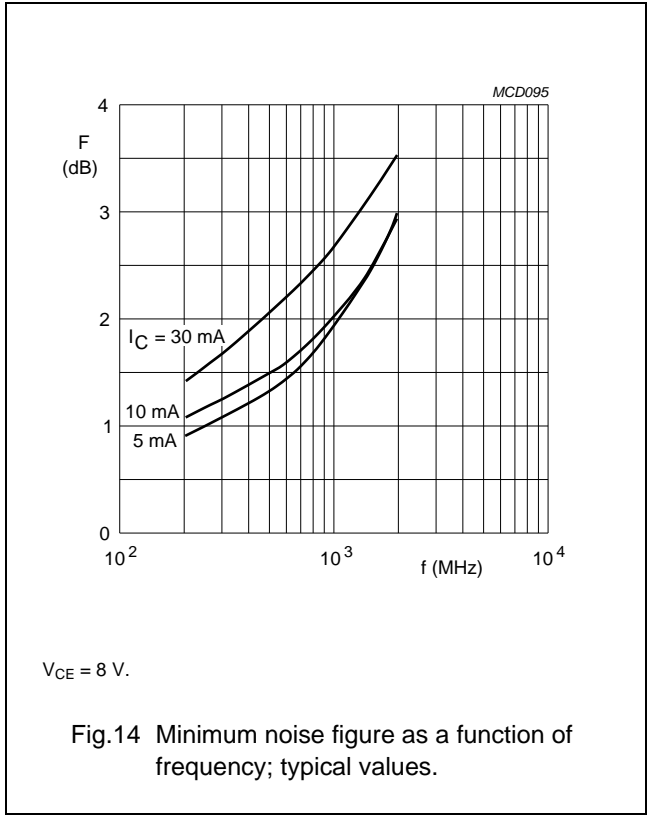
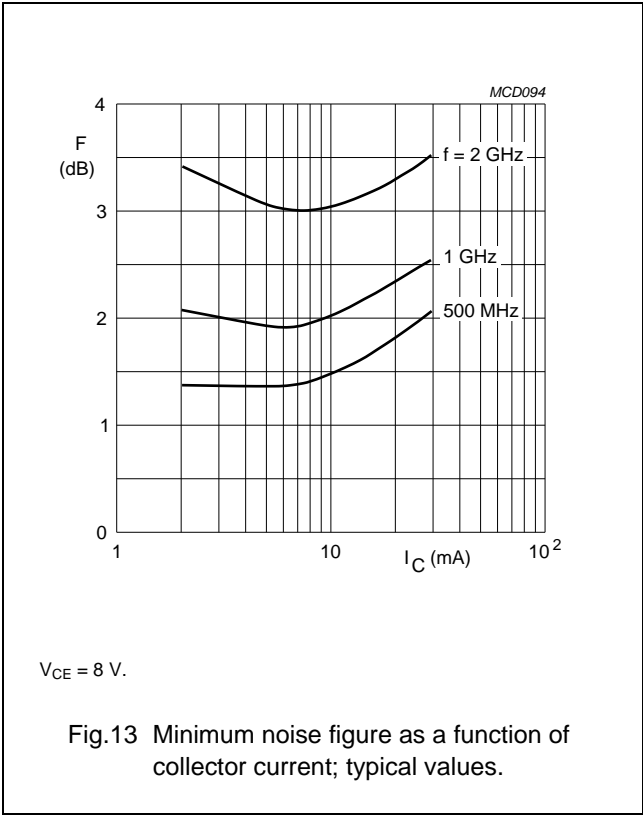
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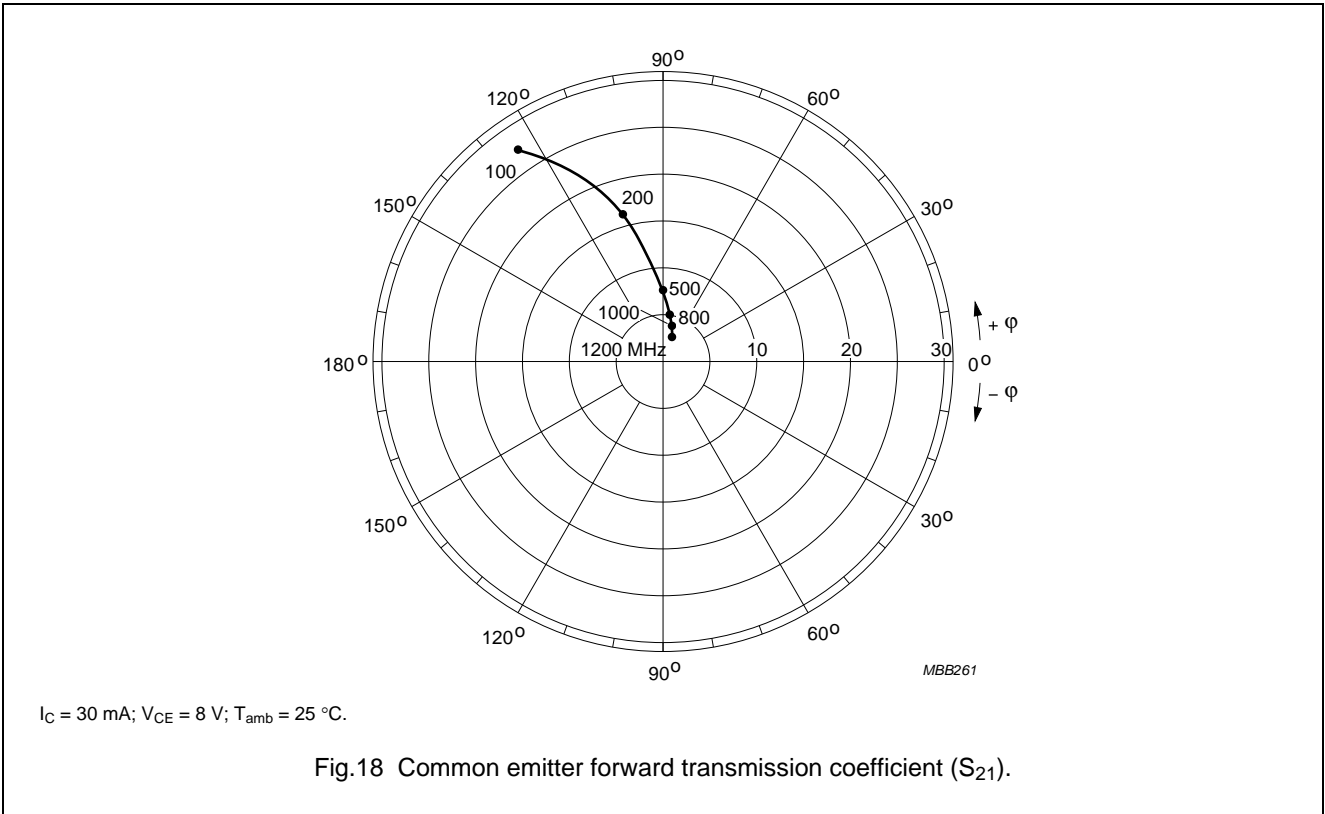
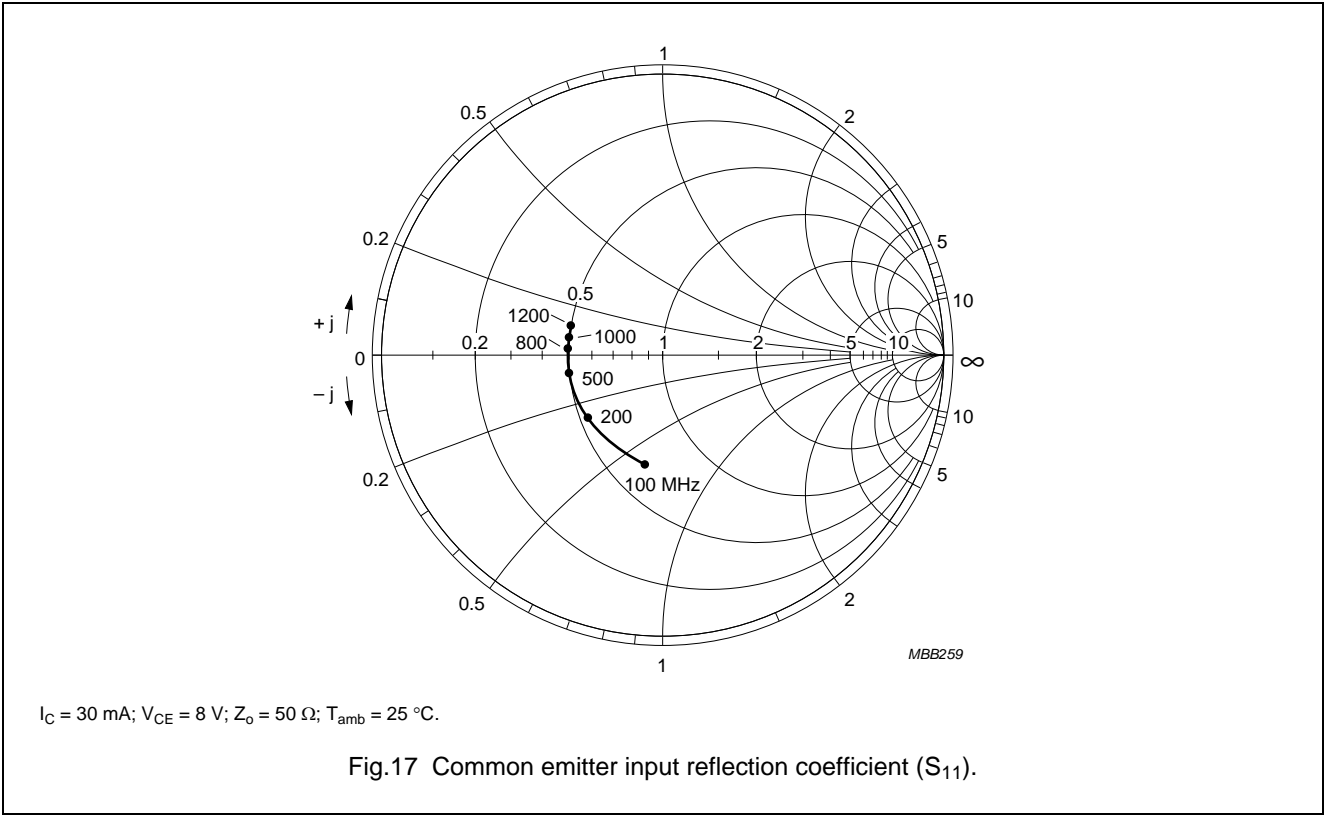
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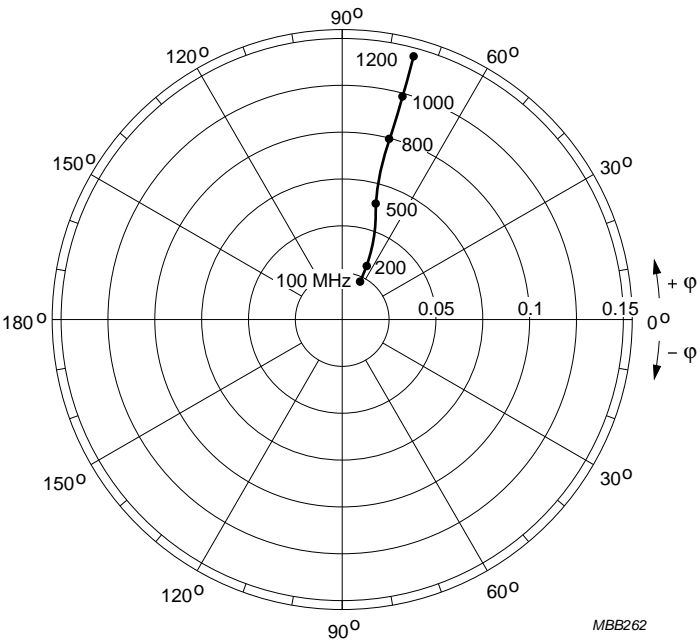
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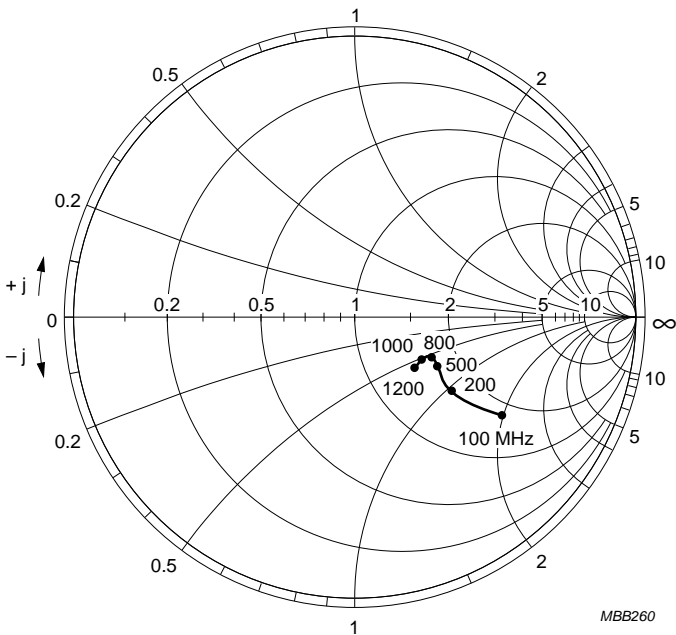
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$I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $T_{amb} = 25\text{ °C}$.

Fig.19 Common emitter reverse transmission coefficient (S_{12}).



$I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $Z_0 = 50\text{ }\Omega$; $T_{amb} = 25\text{ °C}$.

Fig.20 Common emitter output reflection coefficient (S_{22}).

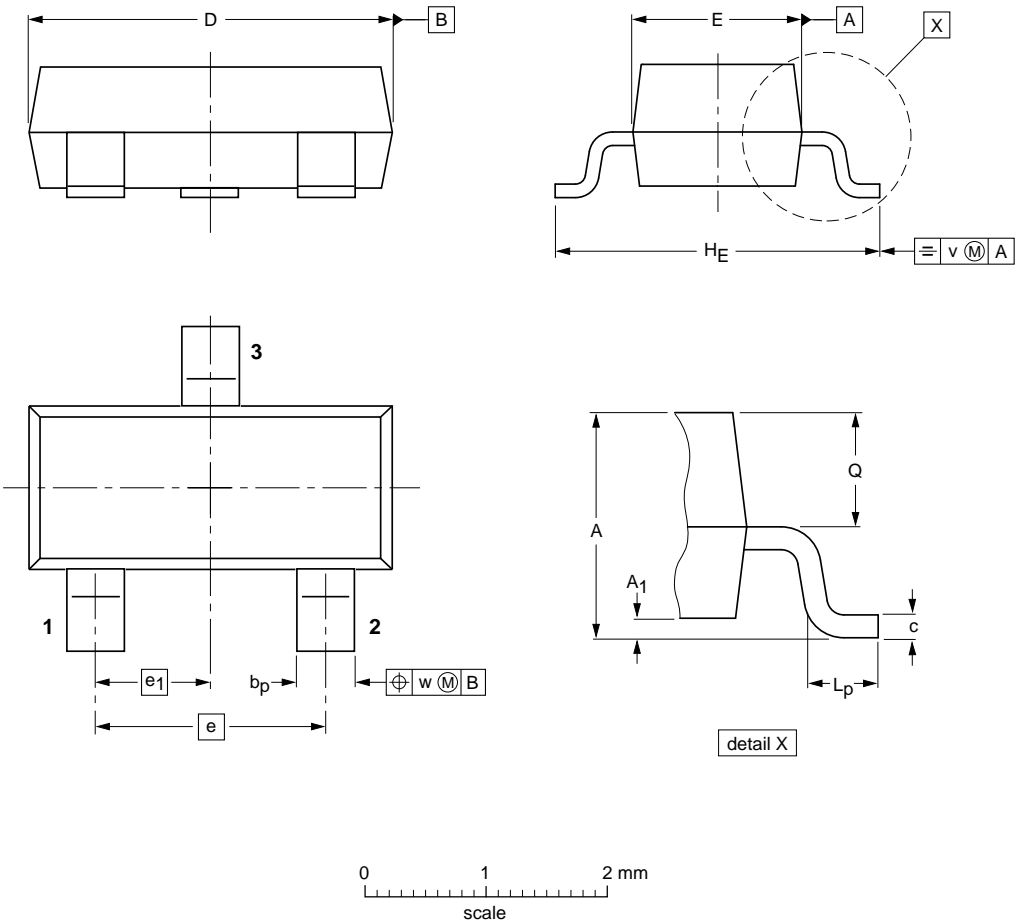
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PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ max. | b _p | c | D | E | e | e ₁ | H _E | L _p | Q | v | w |
|------|------------|------------------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|--------------|-----|-----|
| mm | 1.1 0.9 | 0.1 | 0.48 0.38 | 0.15 0.09 | 3.0 2.8 | 1.4 1.2 | 1.9 | 0.95 | 2.5 2.1 | 0.45 0.15 | 0.55 0.45 | 0.2 | 0.1 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|----------|-------|--|------------------------|---------------------------------|
| | IEC | JEDEC | JEITA | | | |
| SOT23 | | TO-236AB | | | | 04-11-04 06-03-16 |

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DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|--------------------------------|-------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet | Production | This document contains the product specification. |

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